

Title (en)

USE OF ZWITTERIONIC COMPOUNDS AS MOLD-RELEASE AGENTS IN THERMOPLASTIC MATERIALS

Title (de)

VERWENDUNG VON ZWITTERIONISCHEN VERBINDUNGEN ALS ENTFORMUNGSMITTEL IN THERMOPLASTEN

Title (fr)

UTILISATION DE COMPOSES ZWITTERIONIQUES COMME AGENTS DE DEMOULAGE DANS DES MATIERES THERMOPLASTIQUES

Publication

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Application

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Abstract (en)

[origin: WO02074848A1] The invention relates to the use of zwitterionic compounds as mold-release agents in thermoplastic materials, and to thermoplastic molding compounds provided therewith that have good mold-release properties, as well as to molded articles produced from said molding compounds.

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IPC 8 full level

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